



SPECIFICATIONS

Rated Current: 3.0AMP

Contact Resistance: 20mΩ Max

Withstand Voltage: 1000V AC/DC

Insulation Resistance: 1000MΩ Min

Operation Temperature: -40℃ to +105℃

Contact Material: Copper Alloy

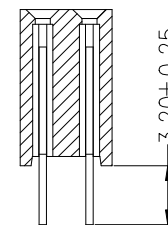
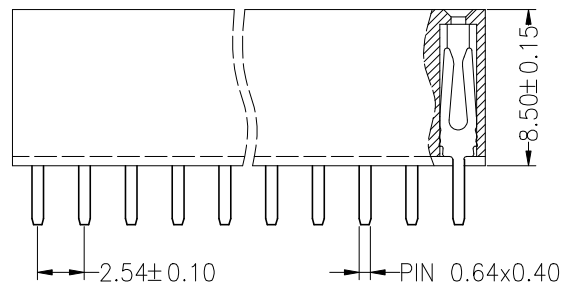
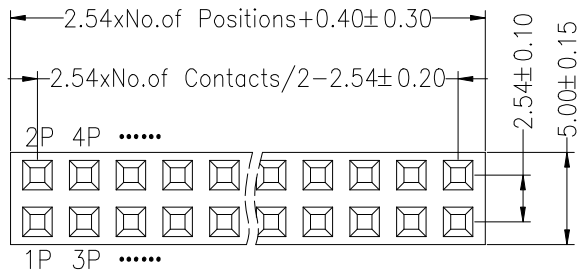
Contact Plating: Au Or Sn Over Ni

Insulator Material: Polyester(UL94V-0)

Resistance To Soldering Heat:

245℃±5℃, 10s(PBT insulator)

260℃±5℃, 10s(PA6T&PA9T&LCP insulator)



Ordering Information

2285 02 XX X N XX S Y X XX

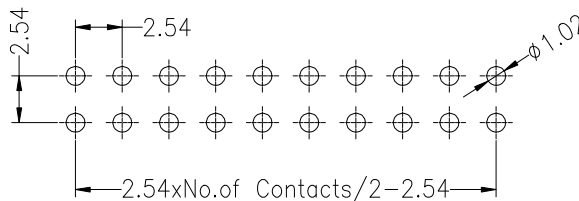
No.of Pins
Per Row
02~40P

Insulator Material
Option
A=BK-PBT
C=BK-PA6T
E=BK-PA9T
F=BK-LCP

Contact Plating
G1:Gold Flash
G2:1.5u" Gold
G3:2u" Gold
G4:3u" Gold
G5:5u" Gold
G6:10u" Gold
G7:15u" Gold
G8:30u" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
A=Tray
T=Tube

code stream
01~99



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

				OPERATION		DRAW	RICH LIN	12.11.14	SCALE	FIT	JILN®深圳锦凌电子股份有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5588	
				X.X	±0.30				CHECK			
				X.XX	±0.20	SIZE	A4					
A0	2012.11.14	NEW DRAWING		X.XXX	±0.10	APPROVE		SHEET	1/1	PART NO.	228502XXXXXXSYXXX	
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	Angle	±3°			PROJ.		TITLE:	2.54PF H8.5mm 2xNpin 180°	
				DIM	TOL							